

L Number	Hits	Search Text	DB	Time stamp
-	44	(copper adj alloy) and 174/117f.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 16:00
-	2352	copper near silver near alloy	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 16:18
-	85	174/\$.ccls. and (copper near silver near alloy)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 16:18
-	2428	copper same silver same alloy same weight	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 16:18
-	101	174/\$.ccls. and (copper same silver same alloy same weight)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 17:00
-	3	((copper-silver-silicon) (cu-ag-si))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 17:26
-	8154	(cross-sectional adj area) same (conductor wire)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 17:00
-	649	174/\$.ccls. and ((cross-sectional adj area) same (conductor wire))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 17:01
-	66	(174/117f.ccls. 174/113r.ccls.) and ((cross-sectional adj area) same (conductor wire))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 17:18
-	131	copper near silver near silicon	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 17:39
-	7328	(copper cu) same (ag silver) same (si silicon) same alloy	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 17:40
-	2626	(conductor wire cable) and ((copper cu) same (ag silver) same (si silicon) same alloy)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 17:41
-	249	(tensile adj strength) and ((conductor wire cable) and ((copper cu) same (ag silver) same (si silicon) same alloy))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 17:41
-	96	elongation and ((tensile adj strength) and ((conductor wire cable) and ((copper cu) same (ag silver) same (si silicon) same alloy)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 17:44

-	32	(copper adj alloy) and 174/128.1.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 18:40
-	6	(copper adj alloy) and 174/128.2.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 18:43
-	155	copper and (174/128.1 174/128.2).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 18:43
-	376	strand same (copper adj alloy)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 10:50